

**S/N 10/774,869**

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Song-Hua Shi et al.

Examiner: Junghwa M. Im

Serial No.: 10/774,869

Group Art Unit: 2811

Filed: February 9, 2004

Docket No.: 884.698US2

Title: UNDERFILL PROCESS FOR FLIP-CHIP DEVICE

Customer Number: 21186

**RESPONSE UNDER 37 CFR § 1.111**

MS Amendment

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

This responds to the Office Action mailed on August 22, 2007. Please consider the remarks in connection with the above-identified patent application as follows.

This response is accompanied by a Petition, as well as the appropriate fee, to obtain a one-month extension of the period for responding to the Office action, thereby moving the deadline for response from November 22, 2007 to December 22, 2007. Since December 22, 2007 falls on a Saturday, it is believed that the due date carries over to the next business day, Wednesday, December 26, 2007 (Monday, December 24, 2007 and Tuesday, December 25, 2007 were federal holidays).